MEMC Datasheet

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1. Introduction

The Memory Controller (MEMC) acts as the interface between the ARM (Acorn RISC Machine) processor, Video Controller (VIDC), I/O Controllers (including IOC), Read-Only memories (ROM) and Dynamic memory devices (DRAM), providing all the critical system timing signals.

Up to 4MBytes of DRAM may be connected to MEMC, which provides all signals and refresh operations for a wide variety of standard DRAMs. A Logical to Physical Address Translator maps the Physical memory into a 32MByte Logical address space (with three levels of protection) allowing Virtual Memory and Multi-Tasking operations to be implemented. Fast "page mode" DRAM accesses are used to maximise memory bandwidth.

MEMC supports Direct Memory Access (DMA) read operations with a set of programmable DMA Address Generators, which provide a circular buffer for Video data, a linear buffer for Cursor data, and multiple bufer for Sound data.

FEATURES

* Directly drives standard Dynamic RAMs
* Supports up to 4MBytes of real memory
* Logical to Physical address translation
* Three protection levels supported
* Uses fast "Page mode" DRAM accesses to maximise memory bandwidth
* Internal DMA address generators for Video, Cursor and Sound data buffers
* Arbitrates memory between the processor and DMA.
* Many ROM speeds supported
* Provides all critical system timing signals, including processor clocks.
* Fabricated in CMOS for low power

2. Block Diagram
3. Functional Diagram

4. Description of Signals

<table>
<thead>
<tr>
<th>Name</th>
<th>Pin</th>
<th>Type</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>A[0:25]</td>
<td>26-10,8-1,68</td>
<td>IC</td>
<td>Processor address lines.</td>
</tr>
<tr>
<td>R/W</td>
<td>62</td>
<td>IC</td>
<td>Processor Not-Read/Write. Determines the direction of data flow during processor memory accesses. (Note 1)</td>
</tr>
<tr>
<td>B/W</td>
<td>63</td>
<td>IC</td>
<td>Processor Not-Byte/Word. Determines whether a processor memory access is byte-wide (8-bits) or word-wide (32-bits). (Note 1)</td>
</tr>
<tr>
<td>MREQ</td>
<td>55</td>
<td>IC</td>
<td>Processor memory request. This signal should be set LOW if the processor will be accessing memory in the next processor cycle. (Notes 1,2)</td>
</tr>
<tr>
<td>SEQ</td>
<td>54</td>
<td>IC</td>
<td>Processor sequential access. This signal should be set HIGH if the next processor cycle will access an address sequential to the current address. (Note 2)</td>
</tr>
<tr>
<td>SPVMD</td>
<td>52</td>
<td>IC</td>
<td>Supervisor mode select. The MEMC Supervisor protection mode is selected while this line is HIGH. (Note 3)</td>
</tr>
<tr>
<td>PH1, PH2</td>
<td>66, 65</td>
<td>OC</td>
<td>Processor clocks. These pins drive the two phase, non-overlapping clock inputs of the ARM processor.</td>
</tr>
<tr>
<td>DBE</td>
<td>56</td>
<td>OC</td>
<td>Processor data bus enable. This active HIGH signal enables the processor data bus during processor write cycles, and may be inverted externally to provide an active LOW write enable for the Dynamic RAMs.</td>
</tr>
<tr>
<td>ABORT</td>
<td>53</td>
<td>OC</td>
<td>Processor abort. This line is driven HIGH by MEMC to inform the processor that the current memory access is illegal. (Note 1)</td>
</tr>
<tr>
<td>IOREQ</td>
<td>59</td>
<td>OC</td>
<td>Input/Output cycle request. This signal is driven LOW by MEMC to inform the I/O controllers that an I/O cycle is being requested by the processor.</td>
</tr>
<tr>
<td>REF8M</td>
<td>64</td>
<td>OC</td>
<td>8MHz Reference clock.</td>
</tr>
<tr>
<td>IOGT</td>
<td>58</td>
<td>IC</td>
<td>Input/Output cycle grant. A LOW on this input informs MEMC that the I/O Controller is ready to complete the I/O cycle.</td>
</tr>
<tr>
<td>CK24M</td>
<td>67</td>
<td>IC</td>
<td>24MHz Master clock.</td>
</tr>
<tr>
<td>RESET</td>
<td>44</td>
<td>IC</td>
<td>Reset input. Active HIGH.</td>
</tr>
<tr>
<td>RA[0:9]</td>
<td>28-37</td>
<td>OT</td>
<td>RAM address bus. Multiplexed Row and Column address lines from MEMC which will drive up to 32 DRAMs without external buffers. (Note 4)</td>
</tr>
<tr>
<td>RAS</td>
<td>38</td>
<td>OT</td>
<td>Row address strobe. The HIGH to LOW transition of RAS strobes the Row address on RA[0:9] into the DRAMs. This line will drive up to 32 DRAMs without external buffers.</td>
</tr>
</tbody>
</table>
### Description of Signals

<table>
<thead>
<tr>
<th>Signal</th>
<th>Type</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>CAS[0:3]</td>
<td>39-42</td>
<td>OT Column address strobes. Each line controls a block of 8-bits of memory; one block for each byte of the 4-byte word. The HIGH to LOW transition of a CAS[0:3] line strobes the Column address on RA[0:9] into the DRAMs. Each line will drive up to 8 DRAMs without external buffers.</td>
</tr>
<tr>
<td>ROMCS</td>
<td>60</td>
<td>OC ROM chip select. This line is driven LOW when the processor accesses the Read Only Memories (ROMs).</td>
</tr>
<tr>
<td>VIDW</td>
<td>51</td>
<td>OC Video Controller write strobe. This line is driven LOW while the processor is performing a write operation to the Video Controller.</td>
</tr>
<tr>
<td>FLYBK</td>
<td>45</td>
<td>IC Video vertical flyback. This signal should be set HIGH while the video retrace is in progress. FLYBK is used to initialise the video and cursor DMA address pointers.</td>
</tr>
<tr>
<td>HSYNC</td>
<td>46</td>
<td>IC Video horizontal synchronisation. Video data requests made while this signal is LOW will obtain data from the cursor data buffer. A video data request made when HSYNC is HIGH obtains data from the video data buffer.</td>
</tr>
<tr>
<td>VDRQ</td>
<td>48</td>
<td>IC Video data request. A LOW on this line requests a video or cursor DMA operation (depending on the sense of HSYNC).</td>
</tr>
<tr>
<td>VDAK</td>
<td>50</td>
<td>OC Video data acknowledge. This line is driven LOW to indicate that the requested video/cursor data is being fetched from RAM. The data should be latched on the rising edge of VDAK.</td>
</tr>
<tr>
<td>SNDRQ</td>
<td>47</td>
<td>IC Sound data request. A LOW on this line requests a sound DMA operation.</td>
</tr>
<tr>
<td>SNDAK</td>
<td>49</td>
<td>OC Sound data acknowledge. This line is driven LOW to indicate that the requested sound data is being fetched from RAM. The data should be latched on the rising edge of SNDAK.</td>
</tr>
<tr>
<td>SIRQ</td>
<td>57</td>
<td>OC Sound interrupt request. This line is driven LOW to request a sound service interrupt operation from the processor. SIRQ is set LOW on reset.</td>
</tr>
<tr>
<td>VSS</td>
<td>27,61</td>
<td>PWR Ground supply.</td>
</tr>
<tr>
<td>VDD</td>
<td>9,43</td>
<td>PWR Positive supply.</td>
</tr>
</tbody>
</table>

### Key to Signal Types:
- IC CMOS compatible input
- OC CMOS compatible output
- OT TTL compatible output
- PWR Power pins

### NOTES:
1. The word "Memory" in this context refers to any device mapped into the processor's address space.
2. Some of the processor signals are asserted in the processor cycle preceding that in which they are used.
3. SPYMD is generally connected to the TRANS pin of the ARM processor.
4. The bit order and logic level of the RA[0:9] RAM address bus changes according to the Page size selected in MEMC (see Appendix A).
5. General Description

5.1 Protection Modes
MEMC may be operated in three protection modes:

(i) **Supervisor Mode**

Supervisor mode is selected while the SPVMD input is held HIGH. This is the most privileged mode, allowing the entire memory map to be freely accessed.

(ii) **Operating System Mode (OS Mode)**

OS mode is selected by setting a control bit in the MEMC Control Register (which may only be done from Supervisor mode). OS mode is more privileged than User mode when accessing Logically Mapped RAM, but acts like User mode in all other cases.

(iii) **User Mode**

User mode is the least privileged of the three protection modes. Unprotected pages in the Logically Mapped RAM may be accessed when in User mode, and the ROM space may be read, but no other accesses are allowed.

All attempts to access protected addresses from an insufficiently privileged mode (User mode or OS mode) will activate the ABORT line without performing the access.

5.2 Memory Pages

MEMC treats the DRAM it controls as a set of 128 sequential Physical Pages. The Page is the fundamental unit of memory used by MEMC, and the Page Size may be selected as 4, 8, 16 or 32 KBytes by programming the MEMC Control Register.

The page size selection affects the DRAM address multiplexer, so it is essential to choose the correct page size for the amount of memory being controlled. Table 1 shows the page size selections for most DRAM configurations. When less than 512KBytes of DRAM is connected to MEMC, a page size of 4KBytes should be used, but note that two or more Physical pages will now map onto the same address in the DRAM.

5.3 Memory Map

MEMC accepts 26 address lines from the processor, A[0:25], which are decoded as shown by the memory map in Figure 1.

5.3.1 Logically Mapped RAM (Read/Write: 0000000H - 1FFFFFFH)

The bottom 32MBytes of the memory map consists of Logically mapped RAM. MEMC treats this area of the map as a set of contiguous Logical Pages (there may be 8192, 4096, 2048 or 1024 Logical pages depending upon the page size selected).

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1 The MEMC Page unit should not be confused with the "Page mode access" capability of Dynamic RAMS.

![Figure 1: Processor memory map as decoded by MEMC](image)
### Table 1: Recommended Page size settings

<table>
<thead>
<tr>
<th>Total amount of DRAM</th>
<th>Number of Pages</th>
<th>Number of Physical Pages</th>
<th>Number of Logical Pages</th>
</tr>
</thead>
<tbody>
<tr>
<td>512 KBytes</td>
<td>4 KBytes</td>
<td>128</td>
<td>8192</td>
</tr>
<tr>
<td>1 MBytes</td>
<td>8 KBytes</td>
<td>128</td>
<td>4096</td>
</tr>
<tr>
<td>2 MBytes</td>
<td>16 KBytes</td>
<td>128</td>
<td>2048</td>
</tr>
<tr>
<td>4 MBytes</td>
<td>32 KBytes</td>
<td>128</td>
<td>1024</td>
</tr>
</tbody>
</table>

When a Logical page is accessed, the Logical to Physical Address Translator attempts to convert the Logical Page Number to a Physical Page Number. Provided that the mapping exists, and the request is being made in a sufficiently privileged mode, the appropriate Physical page will be accessed. If the mapping does not exist, or the access is made with insufficient privilege, MEMC will signal the processor by setting the ABORT line HIGH, and the DRAM will not be activated.

The logical to physical mapping and protection status of each Logical page is undefined at power on, but may be programmed at any time by writing to the Logical to Physical Address Translator.

#### 5.3.2 Physically Mapped RAM (Read/Write: 2000000H - 2FFFFFFH)

The physically mapped RAM occupies 16MBytes of the memory map, and may only be accessed when Supervisor mode is selected. The 128 Physical pages appear sequentially in this area of the map, with the RAM image being repeated after every 128th page (so that, with a page size of, say, 8KBytes, the entire 1MByte of RAM would occur 16 times throughout this area).

#### 5.3.3 Input/Output Controllers (Read/Write: 3000000H - 3FFFFFFH)

This area of the map is reserved for I/O Controllers (including IOC). When a Supervisor mode access is made in this memory range, MEMC asserts IORQ (I/O cycle request), and stops the processor clocks. The I/O cycle terminates after both IORQ and IOTG are seen LOW on the rising edge of REF8M.

**NOTE:** Care must be taken not to access a non-existent I/O Controller, otherwise MEMC will wait indefinitely for an active IOTG signal that never appears, and the processor will stop until RESET is asserted.

#### 5.3.4 ROM (Read: 3400000H - 3FFFFFFH)

Read Only Memory may be read freely from any protection mode. The ROM space is divided into two areas:

1. **Low ROM (4MBytes from 3400000H to 37FFFFFH)**
2. **High ROM (8MBytes from 3800000H to 3FFFFFFH)**

The two ROM areas are distinguished only by the fact that each may be programmed to operate at its own speed. This would allow the High ROM area to contain fast system ROMs, with slower applications ROMs in the Low ROM area.

The ROM speeds default to the slowest setting when RESET is asserted, and may be altered by reprogramming the MEMC Control Register.

#### 5.3.5 Video Controller (Write: 3400000H - 3FFFFFFH)

A write operation made anywhere in the Video Controller space (while MEMC is in Supervisor mode) activates the VIDE output from MEMC.

#### 5.3.6 Address Generators & Control Register (Write: 3600000H - 3FFFFFFH)

This address space decodes to some of MEMC's internal registers. The DMA Address Generators supply the Physical RAM address used to obtain data during Video, Cursor and Sound Direct Memory Access operations, and the MEMC Control Register controls a number of the functions of MEMC.

The processor data bus is not connected to MEMC; instead, the internal registers are programmed by encoding the data in the address bus, and performing a write operation with MEMC in Supervisor mode.

#### 5.3.7 Logical to Physical Address Translator (Write: 3800000H - 3FFFFFFH)

The mapping of Logical pages to Physical pages, and protection mode associated with each mapping, may be controlled by programming the Logical to Physical Address Translator. The Address Translator is programmed by encoding data in the address lines, and performing write operations in Supervisor mode to this area of the memory map.
5.4 Effect of Reset

When the RESET line is taken HIGH, MEMC initialises to the following state:

- Memory Map
  The ARM processor starts executing code from location 0000000H after RESET goes inactive. To ensure that the processor always finds valid code at this location (which is normally logically mapped RAM), MEMC continually enables ROM.
  To restore the normal memory map, the processor must first perform a memory access with the address lines A[25] and A[24] both LOW, and then perform a memory access with address line A[25] HIGH. These conditions are satisfied when the processor starts executing instructions from location 0000000H, and later jumps to the normal ROM space.
  Note that a processor write operation should not be performed while ROM is continually enabled, or a data bus clash will occur.

- ROM access times
  The ROM access times for both High and Low ROM are reset to 450ns.

- Page sizes
  The DRAM page size defaults to 4KBytes.

- Operating System mode
  The Operating System mode is disabled.

- Direct Memory Access (DMA) operations
  Sound DMA operations are disabled. Video and Cursor DMA operations are unaffected by reset.

- Sound Interrupts
  The Sound Interrupt pin, SHIRQ is set LOW. The interrupt may be removed by initialising the Sound DMA buffers in the DMA Address Generators, (see Section 6.7.3)

- IO cycle request
  The IRQ line is held HIGH during reset to avoid accidentally triggering an I/O controller if the processor generates spurious addresses while RESET is active.

- Test mode
  The Test mode is disabled by RESET. Test mode is only used for functional testing of MEMC out of the system.

6. Functional Description

6.1 Introduction

6.1.1 Access Times

A number of devices appear in the processor memory map:

- Dynamic Random Access Memory (DRAM)
- Read Only Memory (ROM)
- Input/Output Controllers
- Video Controller
- MEMC internal registers:
  (i) MEMC Control Register
  (ii) DMA Address Generators
  (iii) Logical to Physical Address Translator

These devices have very different access times, ranging from 125ns for DRAMs in page-mode to over 1ms for handshake driven IO cycles. MEMC synchronises the processor with the device it is accessing by stretching the processor clocks, PH1 and PH2.

The processor is the default user of the data bus and memory. However, DMA (Direct Memory Access) and refresh operations require control of the DRAM and data bus, so MEMC disables the processor temporarily during these operations by tri-stating the processor data bus (using DBE), and holding the processor clocks.

6.1.2 N-cycles and S-cycles

MEMC uses the page mode access capability of DRAMs, where, once a row address has been strobed into the DRAM, any column in that row may be accessed merely by strobing in the new column address.

This facility is used whenever a number of sequential addresses in the DRAM are to be accessed (either by the processor or during a DMA operation). The first memory access in the sequence is a Non-sequential memory cycle (where both the row and column addresses are strobed to the DRAMs). The subsequent memory accesses are Sequential memory cycles (where the previous row address is held, and only the column address is strobed to the DRAMs). Sequential memory cycles may also be used with nibble-mode ROMs, where the access time is reduced if only the low order address bits are changed.

The terms N-cycle and S-cycle refer to Non-sequential and Sequential accesses in DRAM or nibble-mode ROM.
6.2 Processor (ARM) Interface

6.2.1 Processor cycles

There are two basic types of processor operation:

(i) Memory access cycles

- Where the processor accesses a device in its address space.

(ii) Internal cycles

- Where the processor is performing an internal operation, and so does not access any external devices.

6.2.2 Processor signals

- Address bus [A0h:251]

  The processor address bus is decoded by MEMC to give the processor access to the various devices.

  Much of the processor memory map is only accessible while MEMC is in Supervisor mode (which is selected by taking the SPVMD line HIGH).

- Memory request [siREQ]

  This signal determines whether the next processor cycle will be a memory access or internal cycle.

- Not-Read/Write [B/W]

  Determines the direction of data flow during processor memory access cycles. This signal is ignored during processor internal cycles.

- Not-Byte/Word [B/W]

  Selects a byte (8-bit) or word (32-bit) data transfer during processor memory access cycles. A byte access to Physically and Logically Mapped RAM only enables the appropriate 8-bit block of DRAMs. ROM accesses always return a word quantity, regardless of the state of B/W. This signal is ignored during processor internal cycles.

- Sequential access [SEQ]

  A HIGH on this line indicates that the processor will generate a sequential address during its next cycle. MEMC uses SEQ to determine whether a fast S-cycle may be used during the next DRAM or nibble-mode ROM access.

- Supervisor mode [SPVMD]

  A HIGH on this line puts MEMC into Supervisor mode, allowing the processor to access restricted areas of the memory map.

6.2.3 Processor controls

- Processor clocks [PH1, PH2]

  MEMC provides the processor with two non-overlapping clocks, PH1 and PH2. Memory access cycles are nominally 250ns long, with PH1 HIGH for approx 175ns, and PH2 HIGH for approx 55ns, but the following exceptions apply:

  (i) Sequential DRAM & nibble-mode ROM accesses

     DRAM and nibble-mode ROM S-cycles only take 125ns to complete, so the processor is given an 8MHz clock while S-cycles are in progress (see Section 8.4).

  (ii) ROM accesses

     ROM access times vary from 450ns to 200ns. PH1 is held HIGH long enough to meet the ROM access time requirement. (see Section 8.5)

  (iii) IO cycles

     IO cycles take a variable length of time to complete. During the longer IO cycles, the processor is suspended by holding PH2 HIGH until the IO Controller is ready to complete the cycle. Suspending the processor during its PH2 phase allows the IO cycle to be completed quickly when the IO Controller is ready.

  (iv) DMA and refresh operations

     DMA and refresh operations have priority over most processor memory access cycles (S-cycles are uninterruptable). A processor memory access is suspended during DMA and refresh operations by disabling the processor data bus drivers (using DBE), and holding the PH1 clock HIGH until the operation has finished. The processor then continues with its delayed memory access (unless another DMA/refresh operation is pending).

     DMA and refresh operations may also occur during long IO cycles. In this case, the IO cycle is delayed until the DMA/refresh operation completes.

     Internal cycles are always 125ns long, with PH1 and PH2 each HIGH for approx 55ns.

- Data bus enable [DBE]

  Enables the processor data bus during processor write cycles. This signal may also be inverted externally, and used as a DRAM write enable signal.

- Memory access abort [ABORT]

  Warns the processor that the requested access is illegal (either because an attempt was made to access a protected address while MEMC was in an insufficiently privileged mode, or an access to a non-existent Logical page was attempted).
6.3 Dynamic RAM (DRAM) Interface

MEMC interfaces directly to most standard Dynamic RAMs, providing a 10-bit multiplexed RAM address bus, RA[0:9], a row address strobe, RAS, and a set of four column address strobes, CAS[0:3].

6.3.1 Byte and Word accesses

The DRAM is divided into four blocks of eight bits, with CAS[0], CAS[1], CAS[2] and CAS[3] each controlling a block (CAS[0] is the least significant block, and CAS[3] is the most significant).

The processor Byte/Word select line, B/W, selects whether a whole word (32-bits) or a single byte (8-bits) is to be read from or written to DRAM. During a word access, all four blocks are activated, allowing the full 32-bits to be accessed. During a byte access, the two least significant address bits, A[0:1], select one of the 8-bit blocks to be activated, and only the appropriate eight bits are read from or written to the DRAMs.

6.3.2 DRAM Configurations

The Page Size setting (in the MEMC Control Register) controls how the DRAM address is presented on the RAM address bus, RA[0:9], as shown in Table 2.

<table>
<thead>
<tr>
<th>Total amount of RAM</th>
<th>Page Size setting</th>
<th>Typical Configuration</th>
<th>Row &amp; Column address presented on</th>
<th>Bank Select</th>
</tr>
</thead>
<tbody>
<tr>
<td>256 KBytes</td>
<td>4 KBytes</td>
<td>8 64Kx4 DRAM</td>
<td>RA[0:7]</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>32 64Kx1 DRAM</td>
<td></td>
<td></td>
</tr>
<tr>
<td>512 KBytes</td>
<td>4 KBytes</td>
<td>16 64Kx4 DRAM</td>
<td>RA[0:7]</td>
<td>RA[8]</td>
</tr>
<tr>
<td>1 MBytes</td>
<td>8 KBytes</td>
<td>8 256Kx4 DRAM</td>
<td>RA[0:8]</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>32 256Kx1 DRAM</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2 MBytes</td>
<td>16 KBytes</td>
<td>16 256Kx4 DRAM</td>
<td>RA[0:8]</td>
<td>RA[9]</td>
</tr>
<tr>
<td>4 MBytes</td>
<td>32 KBytes</td>
<td>8 1Mx4 DRAM</td>
<td>RA[0:9]</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>32 1Mx1 DRAM</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Table 2: Dynamic RAM address bus configurations

NOTES:

(i) The RA[0:9] lines are derived from the processor address bus, the Logical to Physical Address Translator and the DMA Address Generators by passing the lines through the DRAM Address Multiplexer, which inverts and re-orders the address bits. See Appendix A.

(ii) When only 256KBytes are connected to MEMC (8 off 64Kx4 or 32 off 64Kx1 DRAMs), the Bank select address bit, RA[8] is ignored by the DRAMs, so Physical pages 64-127 map onto Physical pages 0-63.
There are three basic Dynamic RAM configurations as follows:

1. Thirty-two 64Kx1, 256Kx1 or 1Mx1 DRAMs

   ![Diagram of 32 DRAMs configuration]

   This configuration splits the thirty-two 1-bit wide DRAMs into four blocks of eight bits. Each 8-bit block is controlled by one of the CAS[0:3] lines, allowing independent access to any of the byte-wide blocks.

   The DRAM write-enable line is derived by inverting the DBE signal from MEMC. The RAM address bus, RA[0:9], and RAS strobe are routed to all the DRAMs.

2. Eight 64Kx4, 256Kx4 or 1Mx4 DRAMs

   ![Diagram of 8 DRAMs configuration]

   This configuration is essentially the same as that used for the 1-bit wide DRAMs. In this case, only eight chips are required for the full 32-bit data bus.

3. Sixteen 64Kx4 or 256Kx4 DRAMs

   ![Diagram of 16 DRAMs configuration]

   The sixteen chips are configured as two banks of eight 4-bit wide DRAMs in parallel. One of the RAM address bits is used as a bank select line (valid at the same time as the Column addresses).

   NOTE: A 2-4 Decoder (with active LOW outputs) is used to derive an output-enable and write-enable signal for each bank. This ensures that only the one bank is activated during any DRAM access.
6.3.3 DRAM cycles

There are three main types of DRAM accesses as follows:

(i) Processor access (fetching instructions and reading/writing data)
(ii) DMA operation (fetching Video, Cursor or Sound data)
(iii) Refresh operation

MEMC uses the page mode access capability of DRAMs, performing sequential accesses (S-cycles) when possible.

Processor accesses

MEMC monitors a processor signal, SEQ, which indicates that the next processor access will be sequential. If the SEQ signal is LOW in the processor cycle preceding a DRAM access (SEQ is a pipelined signal), an N-cycle DRAM access will be used. Subsequent DRAM accesses will use S-cycles, provided that the SEQ signal is HIGH in the preceding cycle.

DMA operations may not interrupt the processor if it is about to perform an S-cycle memory access, so the maximum number of consecutive S-cycles is restricted to three. This limits the best case DMA latency, whilst retaining the improvement that S-cycles bring. An N-cycle is forced under either of the following conditions:

(i) The processor SEQ signal was LOW in the preceding cycle, indicating that this access would not be to a sequential address.

(ii) The processor address lines A[2] and A[3] were both HIGH in the preceding cycle. This restricts the maximum number of consecutive S-cycles to three.

MEMC includes an optimisation for Non-sequential memory accesses that follow an internal processor cycle. During internal cycles, the ARM processor outputs an address, and sets SEQ HIGH if the address will be valid in the next cycle (see Figure 2). In an internal cycle preceding a processor memory access, the MREQ line will be set LOW. When MEMC sees SEQ HIGH, MREQ LOW and a valid DRAM address on A[0:25] during an internal cycle, it starts a DRAM N-cycle immediately, effectively overlapping the internal cycle with the first half of an Non-sequential cycle. The processor DRAM access can then complete with a DRAM S-cycle, as the row address was strobed in during the internal cycle. This special operation does not occur if the DRAM address has both A[2] and A[3] set HIGH (this is a consequence of the multiple S-cycle limiting logic).

DMA operations

DMA operations always fetch four words (sixteen bytes) of data sequentially from the DRAMs. Thus, DMA operations are composed of an N-cycle read followed by three S-cycle reads.

Refresh operations

A refresh operation is effectively a single N-cycle DRAM read operation, with the exception that the CAS(0:3) lines are not strobed LOW, so the data bus is not driven.

---

3 NOTE: MEMC uses the SEQ to detect sequential accesses, and does not perform its own check on the address bus. If the SEQ signal is asserted incorrectly, the wrong memory page may be accessed.

---

Figure 2: Optimisation for DRAM accesses following internal cycles

6.3.4 DRAM Timing

Timing diagrams for DRAM operations are given in Section 8.4.1, Section 8.4.2 and Section 8.8.2. The CAS(0:3) strobes are generated early in read operations, and late in write operations to improve setup and hold times on the data bus. If an ABORT is generated during an N-cycle, the RAS strobe will be activated as usual, but the CAS(0:3) signals are suppressed for this and any subsequent S-cycles, effectively disabling the DRAM.
6.4 Read Only Memory (ROM) Interface

To give the ROM as long as possible to access its data, the ROM chip select signal from MEMC, ROMCS, is driven LOW at the start of every processor memory access (except 5-cycles), and only disabled when the processor address lines have been decoded as addressing another part of the memory map.

The ROM area of the processor memory map is divided into two sections, High ROM and Low ROM. The ROM access time in each area may be independently programmed through the MEMC Control Register. Four ROM access times are programmable:

(i) 450ns
(ii) 325ns
(iii) 200ns
(iv) 200ns with 60ns nibble-mode

When a ROM cycle is performed, the processor clocks are stretched as necessary to match the ROM access time.

6.5 MEMC Control Register

The MEMC Control Register is a programmable register that controls some of the functions of MEMC. The parameters are encoded into the processor address lines, as shown in Figure 3, and transferred to the Control Register by performing a write operation to the appropriate address whilst MEMC is in Supervisor mode.

![Figure 3: Programming the MEMC Control Register](image-url)
The following functions of MEMC are programmable:

- **Logical and Physical Page size**
  The Logical and Physical page size must be set to correspond to the type of DRAM connected to MEMC. Page sizes of 4KBytes, 8KBytes, 16KBytes or 32KBytes may be selected.
  A default Page size of 4KBytes is selected when RESET is asserted.

- **ROM Access Times**
  ROM access times of 450ns, 325ns, 200ns or 200ns with 60ns nibble-mode may be selected for each of the two ROM areas (High ROM and Low ROM).
  The ROM access time in both High and Low ROM areas defaults to 450ns when RESET is asserted.

- **Refresh Operations**
  Video DMA operations address DRAM locations sequentially at regular intervals, effectively refreshing DRAM, but video DMA operations are normally suspended during flyback.
  For high resolution displays, the flyback time is short enough to ensure that the DRAM refresh period is not exceeded.
  Broadcast standard displays have longer flyback times, and extra DRAM refresh must be provided during flyback to retain DRAM integrity.
  When no Video DMAs are requested, all refresh operations must be generated by MEMC.

To cover these requirements, three modes of refresh operation are available:

(i) **Continuous refresh**
   A refresh operation is attempted every 4ms. The refresh operation uses the DMA Video pointer as the refresh address source, incrementing the pointer after use. As this effectively scrambles the DMA Video pointer, this mode should never be selected while a Video display is being generated.

(ii) **Refresh only during Video flyback**
    A refresh operation is attempted every 4ms while FLYBK is HIGH. This mode should be selected when a broadcast standard Video display is being generated.

(iii) **No refresh**
    This mode of operation disables refresh entirely, relying on Video DMA operations to refresh the DRAM.

Refresh operations take a single N-cycle. The processor clocks are halted during the operation (unless the processor is executing internal cycles) to ensure that the processor does not try to use the DRAM, and the refresh address is strobed into the DRAMs using the RAS line.

The refresh address is provided using the DMA Video pointer, which is incremented after every refresh operation.

Refresh operations have a lower priority than DMA operations and will be delayed if a DMA operation is in progress when the refresh is attempted.

**Functional Description**

- **Direct Memory Access (DMA) control**
  The Video/Cursor and Sound DMA operations may be enabled or disabled as required.
  Sound DMA operations are disabled when RESET is asserted.
  Video/Cursor operations are unaffected by RESET.

- **Operating System Mode**
  When Operating System mode is enabled, the processor may access certain protected Logical pages in the Logically Mapped RAM space. As with all MEMC Control Register parameters, Operating System mode may only be changed while MEMC is in Supervisor mode.
  Operating System mode is disabled when RESET is asserted.

- **Test Mode**
  Test mode reconfigures MEMC to a known state for functional testing of the chip out of the system.
  Test mode must NEVER be enabled during normal operation, as it removes all sources of DRAM refresh, and halts the processor.
  Test mode is disabled when RESET is asserted.
Chapter 6

6.6 Logical to Physical Address Translator

The physical RAM is divided into 128 Physical pages, which the processor may either access directly through the Physically Mapped RAM area of the memory map, or indirectly through the Logically Mapped RAM area (which is composed of Logical pages). The Logical to Physical Address Translator converts the mapping of Logical pages to Physical pages, and allows a level of protection to be attached to each Logical page.

6.6.1 Page Protection Levels

The Logical page Protection Levels available are shown in Figure 4.

<table>
<thead>
<tr>
<th>MEMC Protection Mode</th>
<th>Supervisor</th>
<th>Operating System</th>
<th>User</th>
</tr>
</thead>
<tbody>
<tr>
<td>Page Protection Level (PPL[1:0])</td>
<td>Read/Write</td>
<td>Read/Write</td>
<td>Read/Write</td>
</tr>
<tr>
<td>00</td>
<td>Read/Write</td>
<td>Read/Write</td>
<td>Read/Write</td>
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<tr>
<td>01</td>
<td>Read/Write</td>
<td>Read</td>
<td>Read/Write</td>
</tr>
<tr>
<td>10</td>
<td>Read/Write</td>
<td>Read</td>
<td>Read/Write</td>
</tr>
<tr>
<td>11</td>
<td>Read/Write</td>
<td>Read</td>
<td>Read/Write</td>
</tr>
</tbody>
</table>

Figure 4: Logical page Protection Levels

The protection level is specified by two bits, but two of the four patterns are identical, so only three protection levels are available:

(i) The lowest protection level (PPL[1]=0,PPL[0]=0) allows the Logical page to be freely accessed when MEMC is in any protection mode.

(ii) The medium protection level (PPL[1]=0,PPL[0]=1) allows the Logical page to be freely accessed when MEMC is in Supervisor or OS mode, but prevents write operations from User mode.

(iii) The highest protection level (PPL[1]=1,PPL[0]=X) allows the Logical page to be accessed when MEMC is in Supervisor mode, prevents write operations from OS mode, and disallows any User mode accesses.

If the protection mode of MEMC is insufficiently privileged to access a protected page, or the logical page being accessed has no physical page mapping, the ABORT line will be taken HIGH to inform the processor that the memory operation was aborted, and the CAS[0:3] lines will be held HIGH to ensure the DRAM is not activated.

6.6.2 Address Translator mapping

The Address Translator consists of a 128 entry lookup table. Each of the 128 entries corresponds to a Physical page number. A Logical to Physical mapping is made by storing a Logical page number in the appropriate entry. Each entry also contains the two bit Page Protection Level.

When the processor accesses Logically Mapped RAM, the Logical page number is applied to all 128 table entries simultaneously. If one of the entries contains the required Logical page number, and the current operating mode of MEMC is sufficiently privileged to overcome the Page Protection Level, the appropriate Physical page (the number of the entry that matched) is output to the DRAMs.

If none of the entries match the requested Logical page, or a match is found but the Page Protection Level is too high, the ABORT line is set HIGH, and the DRAM is not activated.

NOTE: It is possible to store the same Logical page number in more than one entry; however, when that Logical page is accessed, those entries will all match, and an invalid Physical page number will result.

6.6.3 Programming the Address Translator

The Address Translator is programmed by specifying the Physical and Logical page numbers that are to be associated and the required protection level.

As MEMC does not monitor the processor data bus, the information is encoded into the address lines, and conveyed to the Address Translator by performing a write operation to the calculated address (with MEMC in Supervisor mode). Note that the page size not only affects the number of Logical pages available, but also changes the bit order in which the Logical and Physical page numbers are specified. Diagrams showing how the information is encoded into an address for each of the four possible page sizes are shown in Figure 5.

NOTES:

(i) The Address Translator is undefined on power up.

(ii) The Address Translator mappings are not affected by reset, but are effectively scrambled if the page size is changed.

(iii) Only one Physical page should be mapped to any given Logical page.
6.7 DMA Address Generators

The DMA Address Generators automatically generate addresses during a DMA service. These DMA addresses are used to obtain 16 bytes of data from the DRAM (all DMA data must be aligned on 16 byte boundaries). The data is obtained using four DRAM accesses; each access supplies one word (four bytes) of data which may be latched from the data bus when the appropriate DMA acknowledge line is strobed.

The DMA Address Generators implement three sets of buffers:

(i) Video Buffer
(ii) Cursor Buffer
(iii) Sound Buffers

These buffers are defined by registers in the DMA Address Generators, which are programmed by encoding the data to the address bus and performing a write operation with MEMC in Supervisor mode. Figure 6 shows how an address is calculated to store data in the Address Generator registers.

Address of Processor write operation:

```
ADDRESS (A25-0)  25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0
REGISTER Vinit 1 1 0 1 1 X 0 0 0 New Register value (see Note 2) XX
Vstart 1 1 0 1 1 X 0 0 1 New Register value (see Note 2) XX
Vend 1 1 0 1 1 X 0 1 0 New Register value (see Note 1) XX
Cinit 1 1 0 1 1 X 0 1 1 New Register value (see Note 1) XX
Sstart 1 1 0 1 1 X 1 0 0 New Register value (see Note 1) XX
SendN 1 1 0 1 1 X 1 0 1 New Register value (see Note 1) XX
Spri 1 1 0 1 1 X 1 1 0
```

NOTES:

(1) The Register value is calculated by dividing the Physical RAM address by 16.
(2) The following side effects occur when the Sound buffer address generators are programmed:
   - Programming the Sstart register sets the Next Sound Buffer Valid flag.
   - Programming the Spri register forces a sound buffer swap.

Figure 6: Programming the DMA Address Generator registers
Chapter 6

NOTES:

(i) The Address Generator works to a resolution of 16 bytes (the number of bytes fetched during a DMA operation), so all DMA buffers must start and end on 16 byte boundaries. The data stored in the Address Generator registers is calculated by dividing the appropriate Physical RAM address by sixteen.

(ii) When the Sound pointer register, Spr, is programmed, no immediate value is specified. Instead, a Sound buffer swap is forced, copying the value from Sstart to Spr, and resetting the Next Sound Buffer Valid flag. (see Section 6.7.3)

(iii) The processor may write to the DMA registers at any time, but multiple, consecutive DMA register write operations (using the ARM Store Multiple instruction) should never be used, as this may inhibit the initialisation of the Video pointer register, Vptr. (see Section 6.7.5)

(iv) The DMA Address generators are limited to addressing the bottom 512KBytes of Physical memory. However, the Logical to Physical Address Translator can be used make this 512KByte Physical address space appear anywhere in the processor's 32MByte Logical address space.

6.7.1 Video Buffer

This is a circular buffer, as shown in Figure 7. The buffer is a section of memory delimited by Vstart and Vend that contains all the Video data for a frame.

![Circular Video Data Buffer](image)

Figure 7: Circular Video Data Buffer

When a Video DMA is requested, the address held in Vptr (the Video Pointer) is used to obtain four consecutive 32-bit words of data (16 bytes) from the DRAM. The VIDAK line is strobed LOW as each word of data is read from the DRAM. The Vptr register is then incremented ready to point to the next four words of Video data, unless it has reached the end of the buffer (as delimited by Vend), in which case Vptr is reset to the start of the buffer (as defined by Vstart).

The Vinit register contains the address to which Vptr will be initialised just before the new display frame begins (denoted by a HIGH to LOW transition on FLYBK), and should be programmed with the address of the first byte of video data for the new frame. Hardware scrolling is effected by reprogramming Vinit.

The processor may program the Vstart, Vinit and Vend registers (provided MEMC is in Supervisor mode). The Vptr register cannot be altered directly by the processor, but is always reset to the value contained in Vinit before a new Video frame is displayed.

The Video Pointer register, Vptr, doubles as a refresh counter. When a refresh is performed, the Vptr address is output to the DRAMs, and Vptr is incremented to the next 16 byte boundary (no check is made that Vptr has reached the end of the buffer). As refresh operations alter the contents of Vptr, continuous refresh must never be enabled while Video DMAs are operative.
6.7.2 Cursor Buffer

This is a linear buffer, and is shown in Figure 8. The cursor data is contained in a section of memory whose initial (low) address is stored in the Cinit register. While FLYBK is HIGH, Cptr (the Cursor Pointer) is initialized to the address held in Cinit. When a Cursor DMA is serviced, the address held in Cptr is sent to the DRAM, and used to obtain four consecutive 32-bit words of data (16 bytes). The Cptr is then incremented ready to point to the next four words of Cursor data.

6.7.3 Sound Buffers

Sound data is divided into areas of memory called sound buffers. The sound system can support any number of sound buffers using the DMA Address Generators and interrupt driven software. Sound data is extracted from one buffer at a time, and when each buffer is exhausted, a new sound buffer is used.

The DMA Address Generators contain information on two sound buffers as follows (see Figure 9):

(i) **Current Sound Buffer**

This is the buffer from which sound data is extracted when a Sound DMA is requested. The address of the next 16 bytes of sound data to be supplied in response to a Sound DMA request is held in the Sound Pointer register, Sptr, and the end of the Current Buffer is delimited by the Current Sound End register, SendC.

(ii) **Next Sound Buffer**

This is the buffer of sound data which will be used once the Current Sound Buffer is exhausted. The Next Sound Buffer is defined by programming the Start and SendN registers. (NOTE: The processor can only ever program the start and end addresses of the Next Sound Buffer).

A hardware flag, Next Buffer Valid, is set when the Next Sound Buffer registers have been programmed.

Figure 8: Linear Cursor Data Buffer

![Figure 8: Linear Cursor Data Buffer](image)

Figure 9: Current and Next Sound Buffers

![Figure 9: Current and Next Sound Buffers](image)
Sound Buffer operation

(1) Sound Buffer swap

When Spr reaches the end of the Current Buffer, it swaps to the start of the Next Buffer, provided the Next Buffer Valid flag is set.

The buffer swap resets the Next Buffer Valid flag, and generates a sound interrupt by driving the SIIRQ pin LOW. The SendC and SendN registers swap over, so that the value previously set up in SendN defines the end of the new Current Buffer.

(2) Next Sound Buffer setup

The processor should react to the sound interrupt by programming the start and end addresses for a buffer containing new sound data (the Next Sound Buffer). The first part of this process is to define the end address by reprogramming SendN.

The processor may now define the start address by reprogramming Start. This fully defines the Next Buffer, setting the Next Buffer Valid flag and driving SIIRQ HIGH. The sequence of events now repeats from Step (1) again.

NOTE: If the processor fails to setup a new Start value before the Sound Pointer reaches the end of the Current Buffer, the Sound Pointer will jump back to the start of the Current Buffer (as defined by the old value of Start), thus repeating the last buffer of sound data.
Initialising the Sound Buffers

The following procedure is recommended for initialising the Sound Buffers to a known state:

1. Initial state
   After reset Sound DMA operations are disabled. To start the sound system, the processor must first fill an area of memory with sound data; this will become the First Sound Buffer.
   
   **NOTE:** The Sound Interrupt line, SIRQ, is set LOW when RESET is asserted.

2. Defining the First Buffer
   The SendN and Sstart registers are then programmed with the end and start addresses of the First Buffer. This drives SIRQ HIGH.

3. Initialising the Sound Pointer
   The Sound Pointer is now defined by performing a write operation to the Spr register. Rather than defining an immediate value to be stored in Spr, this operation forces a buffer swap, copying the contents of Sstart to Spr, swapping over SendN and SendC, and driving the SIRQ pin LOW.

The processor may now enable Sound DMA operations by reprogramming the MEMC Control Register, and handle the sound interrupt in the usual way to set up the Next Buffer.
6.7.4 Processor/DMA memory arbitration

DMA operations read four words from the DRAM. The memory accesses are organised as an N-cycle followed by three S-cycles. As the DMA operation uses the system data bus, the processor must be prevented from performing memory accesses until the DMA has finished.

If both a DMA operation and a processor memory access cycle are pending, the DMA operation will normally have priority, and the processor will be disabled at the end of its current cycle until the DMA operation completes. However, processor S-cycle memory accesses (either to DRAM or nibble-mode ROM) have higher priority than DMA operations, and the DMA operation will be postponed until the processor stops performing S-cycles. Excessive DMA latency is avoided by limiting the maximum number of consecutive processor S-cycles to three.

Processor internal cycles may occur concurrently with DMA operations, but the processor will be disabled if it attempts any memory access cycle during DMA.

The processor is disabled at the start of a cycle by stopping the processor clocks with PHI HIGH.

The DMA request may arrive while the processor is suspended awaiting the completion of an IO cycle. In this case, the IORQ signal is driven HIGH when REF38 next goes LOW. The DMA operation may then begin, and when it completes, the IO cycle is resumed by setting IORQ LOW again (provided no more DMA or refresh operations are pending).

The DBE line is always driven LOW during DMA operations to disable the processor data bus drivers.

6.7.5 DMA handshaking

Video and Cursor DMA operations are mutually exclusive, and are both requested by taking the VIDIRQ line LOW. The HSYNC line determines whether a Video or Cursor operation is to be performed. If HSYNC is LOW when VIDIRQ is driven LOW a Cursor DMA is performed, otherwise a Video DMA is performed.

A Sound DMA operation is requested by taking the SNDIRQ line LOW.

When the DMA operation is performed, the DRAM is accessed, and an acknowledge line, (either VIDAK for Video/Cursor DMA, or SNDAK for Sound DMA) is strobed low as each word of data becomes available on the data bus. The rising edge of VIDAK or SNDAK should be used to latch the DMA data from the data bus.

The appropriate DMA request line (VIDIRQ or SNDIRQ) should be taken HIGH when the first DMA acknowledge is given unless a consecutive DMA is to be performed.

The FLYBK signal prompts MEMC to initialise the Video and Cursor buffer pointers. The Cursor pointer is initialisated during flyback, and the Video pointer is initialisated just after FLYBK goes LOW. The initialisation of the Video pointer is left this late to allow it to be used as refresh pointer during flyback.

The VIDIRQ, SNDIRQ, HSYNC and FLYBK signals may be asynchronous, so they are all passed through two synchronisation latches in MEMC to avoid synchronisation failure.

---

Selecting Video or Cursor DMA operations

The HSYNC signal determines whether a Video or Cursor DMA is to be performed, and is latched on the HIGH to LOW transition of VIDIRQ. The hold time on HSYNC must be sufficient to allow the synchronisation latches in MEMC to capture its state.

When two or more Video/Cursor DMA operations occur consecutively, HSYNC is sampled on the falling edge of the penultimate VIDAK strobe, and its state at this point determines whether the next DMA operation will fetch Video or Cursor data.

The setup and hold requirements of HSYNC are given in Section 8.8.3.

DMA latencies

Video/Cursor DMA requests have a higher priority than Sound requests, and will always be serviced first.

The maximum DMA latency from the time a VIDIRQ or SNDIRQ line is taken low to the first 32-bits of DMA data being read from DRAM is as follows:

(i) Video/Cursor DMA latency

VIDIRQ passes through two synchronisation latches. The delay through these latches varies from approx 10ns to 125ns, depending on the relative phase of VIDIRQ and the internal 8MHz synchronising clock. It then takes 187ns to process the Video request, and prepare to execute a DMA cycle. A further delay of 500ns may be incurred if the processor had just started a worst case uninterruptable DRAM access (N-cycle + three S-cycles with no internal cycles) in the preceding 8MHz internal clock cycle. Finally, it takes 250ns for the DRAM N-cycle read operation to supply the first word of video/cursor data.

Thus, the minimum and maximum delays from VIDIRQ going LOW to the first word of data being available from the DRAMs are:

Minimum Video/Cursor DMA latency = 10+187+250 =450ns

Maximum Video/Cursor DMA latency = 125+187+500+250 =1070ns

(ii) Sound DMA latency

The Sound DMA latency is similar to the Video/Cursor DMA latency. However, Sound DMA operations have a lower priority than Video/Cursor DMA operations, and will be delayed by 625ns for every consecutive Video/Cursor DMA operation that is requested at the same time as, or after SNDIRQ goes LOW.

Thus, the minimum and maximum delays from SNDIRQ going LOW to the first word of data being available from the DRAMs are:

Minimum Sound DMA latency = 10+187+250 =450ns

Maximum Sound DMA latency = 125+187+500+250+(625xDMA16) =1070+(625xDMA16) ns

where DMA16 is the maximum number of consecutive Video/Cursor DMA operations that may occur while the Sound DMA is pending.

---

Some DRAMs may disable their data bus drivers before the DMA acknowledge line goes HIGH. In this case, the dynamic storage time of the data bus is normally sufficient to hold the data valid until it is latched.

---

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Flyback requirements

The Video and Cursor buffer pointers must be reset between one video frame and the next.

The Cursor pointer is initialised during flyback (signalled by FLYBK HIGH). The initialisation takes 250ns and occurs provided that the following conditions are met:

(i) FLYBK is HIGH (signalling that flyback is in operation).

It may take up to 250ns for MEMC to synchronise and process the LOW to HIGH transition of the FLYBK signal.

(ii) The processor is performing a normal memory access (not an S-cycle), but is NOT writing to the DMA Address Generator or the MEMC Control Register.

(iii) No DMA operation is in progress.

(iv) No refresh operation is in progress.

NOTE: These conditions may be satisfied many times during flyback, and the Cursor pointer will be initialised on each occasion. The FLYBK signal must remain HIGH long enough to initialise the Cursor pointer at least once.

The Video pointer is not reset until after FLYBK makes a transition from HIGH to LOW (the end of the flyback period). This allows the Video pointer to be used as a refresh address register during flyback. The initialisation takes 250ns and occurs provided that the following conditions are met:

(i) FLYBK has made a transition from HIGH to LOW (signalling the end of flyback), and the Video pointer has not already been initialised since FLYBK made the transition.

It may take up to 250ns for MEMC to synchronise and process the HIGH to LOW transition of the FLYBK signal.

(ii) The processor is performing a normal memory access (not an S-cycle), but is NOT writing to the DMA Address Generator or the MEMC Control Register.

(iii) No DMA operation is in progress.

(iv) No refresh operation is in progress.

The delay between FLYBK going LOW and the first Video DMA being processed must be long enough to allow the Video pointer to be reset.

6.8 Video Controller (VIDC) Interface

To program the VIDC Video Controller, the processor performs a write operation anywhere in the Video Controller address space while MEMC is in Supervisor mode. The Video Controller register number and data are encoded entirely in a 32-bit word which is available on the processor data bus during the write operation (see the VIDC Datasheet for more detail). MEMC provides a Video Controller Write signal, VIDW, that may be used to latch the information off the data bus.

6.9 I/O Controller Interface

I/O Controllers use a handshaking system to synchronise I/O peripherals with the system data bus. When the processor accesses the I/O Controller address space (while MEMC is in Supervisor mode), MEMC starts an I/O cycle by driving the I/O cycle request line, IORQ, LOW and holding the processor clocks (stretching the processor cycle when PH2 is HIGH). The I/O Controller signals that it is ready to end the I/O cycle by driving the I/O cycle grant line IOGT, LOW. The I/O cycle terminates after both IORQ and IOGT are seen LOW on the rising edge of REF8M, with MEMC driving IOGT HIGH and releasing the processor clocks, and the I/O Controller driving IOGT HIGH on the next falling edge of REF8M.

An I/O cycle is shown if Figure 10. The cycle starts with IORQ being taken low. There then follows a number of 8MHz clock ticks until the I/O Controller is in a position to complete the cycle. The IOGT line is taken low, and both MEMC and the I/O controller see IORQ and IOGT LOW on the rising edge of REF8M, so the I/O cycle terminates on the next falling edge of REF8M.

![Figure 10: I/O Cycle](image)

IO cycles may be interrupted by DMA and refresh operations, as shown in Figure 11. If a DMA or refresh operation is pending, the IORQ signal is driven HIGH when REF8M next goes LOW. The DMA/refresh operation may then begin, and when it completes, the I/O cycle is resumed by setting IORQ LOW (provided no more DMA or refresh operations are pending). The DBE line is always driven LOW during DMA/refresh operations to disable the processor data bus drivers.

NOTE: The I/O Controllers must not drive the data bus when IORQ is HIGH.
Some I/O cycles may only take 250ns as shown in Figure 12. To give the Input/Output Controller adequate time to recognize such operations, MEMC produces the first IORQ early in the I/O cycle.

The extension of IORQ only happens at the start of an I/O cycle; if the IORQ signal is removed during a DMA or refresh operation, it will be reasserted when REF8M goes LOW.

NOTES: Care must be taken not to address a non-existent Input/Output Controller, as MEMC will hold the processor clocks indefinitely until a LOW is seen on the IOGT line, or RESET is set HIGH.
7. DC Parameters

7.1 Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Min</th>
<th>Max</th>
<th>Units</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>VDD</td>
<td>Supply voltage</td>
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<td>VSS+7.0</td>
<td>V</td>
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<td>VDD+0.3</td>
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</tbody>
</table>

NOTE:
(1) These are stress ratings only. Exceeding the absolute maximum ratings may permanently damage the device. Operating the device at absolute maximum ratings for extended periods may affect device reliability.

7.2 DC Operating Conditions

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
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</table>

NOTES:
(1) Voltages measured with respect to VSS.
(2) IC - CMOS compatible inputs.

7.3 DC Characteristics

KEY:
Mes - Values measured from a sample MEMC.
Nom - Nominal values derived from analogue simulations.

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Mes</th>
<th>Nom</th>
<th>Units</th>
<th>Note</th>
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<tbody>
<tr>
<td>IDD</td>
<td>Supply current</td>
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<td>Output short circuit current</td>
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<td>D.C. latch-up current</td>
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<td>IC input leakage current</td>
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<td>OC output HIGH voltage</td>
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<td>Volt</td>
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<td>Cin</td>
<td>Input capacitance</td>
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<td>pF</td>
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NOTES:
(1) Not more than one output should be shorted to either rail at any time, and for no longer than 1 second.
(2) This value represents the D.C. current that the input/output pins can tolerate before the chip latches up.
(3) OC - CMOS compatible outputs.
(4) OT - TTL compatible outputs.
(5) IC - CMOS compatible inputs.
(6) Output current = 3mA
(7) Output current = -3mA
(8) Output current = 10mA
(9) Output current = -10mA
8. AC Parameters

**TEST CONDITIONS**

The AC timing diagrams presented in this section assume that the outputs of MEMC have been loaded with the capacitive loads shown in the "Test Load" column of Table 3; these loads have been chosen as typical of the type of system in which MEMC will be employed.

The output pads of MEMC are CMOS drivers which exhibit a propagation delay that increases linearly with the increase in load capacitance. An 'Output derating' figure is given for each output pad, showing the approximate increase in load capacitance necessary to increase the output time by one nanosecond.

**KEY TO TIMING TABLES**

- Sym - Symbol used in the timing diagrams.
- Mes - Times measured in a sample ARM/MEMC/VIDC/IOC system running at 8MHz.
- Nom - Nominal times.
- Lim - Times required to meet ARM/MEMC/VIDC/IOC system specifications.

<table>
<thead>
<tr>
<th>Output Signal</th>
<th>Test Load (pF)</th>
<th>Output derating (pF/ns)</th>
<th>Note</th>
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<td>CAS[0:3]</td>
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(1) To maintain PH1/PH2 non-overlap, the capacitive load on PH1 and PH2 should not exceed 25pF.

*Table 3: AC test loads*
8.1 Input Clock

8.2 Processor Signals

**NOTE:**

(1) Transitions on SPVMD should normally occur only while PH2 is HIGH. If SPVMD changes during the PH2 LOW period of an access to a protected area of memory (including protected Logical pages), the access may not be allowed or altered as expected.
8.3 Processor Controls

**NOTES:**

1. The ARM processor clocks must never overlap.

2. Most processor cycles take 250ns, with PH2 LOW for 187ns and HIGH for 62ns. The following exceptions apply:
   - Processor internal cycles take 125ns.
   - DRAM and nibble-mode ROM S-cycle memory accesses take 125ns.
   - ROM read operation cycle time is selectable, and may take 250ns, 375ns or 500ns.
   - The processor clocks are suspended during I/O cycles, with PH2 being held HIGH until the end of the I/O cycle.
   - PH2 may be held LOW during DMA and refresh operations.

3. The ABORT setup and hold limits for the ARM processor were measured for a sample ARM. A factor of two should be allowed for process variations.
8.4 Processor accessing Dynamic RAM

8.4.1 Processor - Dynamic RAM read cycles

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</tbody>
</table>
8.4.2 Processor - Dynamic RAM write cycles

<table>
<thead>
<tr>
<th>Sym</th>
<th>Parameter</th>
<th>Max</th>
<th>Nom</th>
<th>Lim</th>
<th>Units</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>t23</td>
<td>DRAM N-cycle: PH2 LOW</td>
<td>196</td>
<td>187</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t24</td>
<td>DRAM N-cycle: PH2 HIGH</td>
<td>54</td>
<td>62</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t25</td>
<td>DRAM S-cycle: PH2 LOW</td>
<td>71</td>
<td>62</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t26</td>
<td>DRAM S-cycle: PH2 HIGH</td>
<td>54</td>
<td>62</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t27</td>
<td>RAS enable time</td>
<td>110</td>
<td>105</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t28</td>
<td>RAS disable time</td>
<td>8</td>
<td>0</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t29</td>
<td>Row Address setup</td>
<td>93</td>
<td>40</td>
<td>0</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t30</td>
<td>Row Address hold</td>
<td>26</td>
<td>20</td>
<td>15</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t37</td>
<td>RAS to CAS[] enable (write)</td>
<td>79</td>
<td>83</td>
<td>25</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t38</td>
<td>CAS[] pulse width (write)</td>
<td>63</td>
<td>62</td>
<td>60</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t39</td>
<td>CAS[] precharge period (write)</td>
<td>60</td>
<td>62</td>
<td>25</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t40</td>
<td>Column Address setup (write)</td>
<td>34</td>
<td>40</td>
<td>0</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t41</td>
<td>Column Address hold (write)</td>
<td>68</td>
<td>40</td>
<td>20</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t42</td>
<td>RONCS disable time (write cycle)</td>
<td>5</td>
<td>0</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

NOTE:
(1) The DRAM timing limits are given for the particular DRAM used in the test system.
8.5 Processor accessing ROM

8.5.1 Non-sequential ROM access

8.5.2 Sequential ROM access (only with 200ns/60ns nibble-mode ROMs)

```plaintext
<table>
<thead>
<tr>
<th></th>
<th>Non-sequential access</th>
<th>Sequential access</th>
<th>Non-ROM access</th>
</tr>
</thead>
<tbody>
<tr>
<td>PH2</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
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<td></td>
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<td></td>
</tr>
</tbody>
</table>

NOTE:
(1) The basic ROM access time is selectable as 200ns, 325ns or 450ns. PH2 is held LOW to extend the processor cycle, resulting in processor cycle times of 250ns, 375ns and 500ns respectively.
8.6 Processor accessing MEMC Internal Blocks

This timing diagram applies when the processor is writing to:
(i) Logical to Physical Address Translator
(ii) DMA Address Generators
(iii) MEMC Control Register

<table>
<thead>
<tr>
<th>Sym</th>
<th>Parameter</th>
<th>Mes</th>
<th>Non</th>
<th>Lim</th>
<th>Units</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>t3</td>
<td>A[0:25] Address setup</td>
<td>0</td>
<td>0</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t4</td>
<td>A[0:25] Address hold</td>
<td>27</td>
<td>0</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t5</td>
<td>R/W setup</td>
<td>0</td>
<td>0</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t6</td>
<td>R/W hold</td>
<td>33</td>
<td>0</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t42</td>
<td>ROMCS disable time (write cycle)</td>
<td>5</td>
<td>0</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t50</td>
<td>MEMC write: FR2 LOW</td>
<td>196</td>
<td>187</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t51</td>
<td>MEMC write: FR2 HIGH</td>
<td>54</td>
<td>62</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t52</td>
<td>SPIRQ enable/disable time</td>
<td>150</td>
<td></td>
<td>ns</td>
<td></td>
<td>1</td>
</tr>
</tbody>
</table>

NOTE:

(1) The SPIRQ interrupt is affected under the following circumstances:
   - The SPIRQ line is driven HIGH when the DMA Address Generator ‘Start’ register is programmed.
   - The SPIRQ line is driven LOW when the DMA Address Generator ‘Stop’ register is programmed.
8.7 Processor accessing the Video Controller

This timing diagram applies when the processor performs a write operation to the Video Controller area of the memory map.

<table>
<thead>
<tr>
<th>Sym</th>
<th>Parameter</th>
<th>Mes</th>
<th>Nom</th>
<th>Lim</th>
<th>Units</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>t3</td>
<td>A[0:25] Address setup</td>
<td>0</td>
<td>0</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>t4</td>
<td>A[0:25] Address hold</td>
<td>27</td>
<td>0</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>t5</td>
<td>R/W setup</td>
<td>0</td>
<td>0</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>t6</td>
<td>R/W hold</td>
<td>33</td>
<td>0</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>t42</td>
<td>ROMCS disable time</td>
<td>5</td>
<td>0</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td></td>
<td>(write cycle)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>t53</td>
<td>Video Controller write</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>: PH2 LOW</td>
<td>196</td>
<td>187</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>t54</td>
<td>Video Controller write</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>: PH2 HIGH</td>
<td>54</td>
<td>62</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>t55</td>
<td>PH2 LOW to VIDW enable</td>
<td></td>
<td></td>
<td></td>
<td></td>
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</tr>
<tr>
<td></td>
<td></td>
<td>125</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>t56</td>
<td>VIDW pulse width</td>
<td>83</td>
<td>83</td>
<td>&gt;20</td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

NOTE:
(1) The VIDW pulse width limit was measured for a sample VIDC. A factor of two should be allowed for process variations.
8.8 Direct Memory Access (DMA) operations

8.8.1 DMA operation

<table>
<thead>
<tr>
<th>N-cycle</th>
<th>S-cycle</th>
<th>S-cycle</th>
<th>S-cycle</th>
</tr>
</thead>
<tbody>
<tr>
<td>VIDRQ, SNRQ</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VIDAK, SNDAK</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>RAM Data</td>
<td></td>
<td></td>
<td></td>
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<tr>
<td>SIRQ</td>
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</tbody>
</table>

### AC Parameters

<table>
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<tr>
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<th>Mes</th>
<th>Nom</th>
<th>Lim</th>
<th>Units</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>t58</td>
<td>VIDRQ, SNRQ disable time</td>
<td>25</td>
<td>&lt;120</td>
<td>ns</td>
<td>1</td>
<td></td>
</tr>
<tr>
<td>t59</td>
<td>VIDAK, SNDAK pulse width</td>
<td>62</td>
<td>62</td>
<td>&gt;15</td>
<td>ns</td>
<td>2</td>
</tr>
<tr>
<td>t60</td>
<td>VIDAK, SNDAK pulse space</td>
<td>62</td>
<td>62</td>
<td>ns</td>
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<td></td>
</tr>
<tr>
<td>t61</td>
<td>SNDAK to SIRQ active</td>
<td>97</td>
<td>75</td>
<td></td>
<td>3</td>
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</tbody>
</table>

### NOTES:

(1) If VIDRQ is not disabled within 120ns of VIDAK going LOW, a consecutive Video/Cursor DMA operation will result. Similarly, if SNRQ is not disabled within 120ns of SNDAK going LOW, a consecutive Sound DMA operation will result.

(2) The VIDAK and SNDAK pulse width limits were measured for a sample VDIC. A factor of two should be allowed for process variations.

(3) The SIRQ interrupt will be set LOW during sound DMA operations where the Sound pointer swaps from the Current to the Next Sound Buffer.
8.8.2 Direct Memory Access - Dynamic RAM read cycles

<table>
<thead>
<tr>
<th>Non-sequential access</th>
<th>First access</th>
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</thead>
<tbody>
<tr>
<td>WE (See Note)</td>
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<tr>
<td>t27 --&gt;</td>
<td>t28 --&gt;</td>
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<tr>
<td>RAS</td>
<td></td>
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<td></td>
<td></td>
</tr>
<tr>
<td>RA[0:9]</td>
<td>Row</td>
</tr>
<tr>
<td></td>
<td></td>
</tr>
<tr>
<td>CAS[]</td>
<td></td>
</tr>
<tr>
<td>RAM</td>
<td></td>
</tr>
<tr>
<td>Data</td>
<td></td>
</tr>
<tr>
<td>VIDAS, SDAK</td>
<td></td>
</tr>
<tr>
<td></td>
<td>t62 --&gt;</td>
</tr>
<tr>
<td></td>
<td></td>
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<tr>
<td>ROMCS</td>
<td></td>
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</tbody>
</table>

NOTE: WE is obtained by passing DBE through an external inverter.

<table>
<thead>
<tr>
<th>Sym</th>
<th>Parameter</th>
<th>Min</th>
<th>Nom</th>
<th>Lim</th>
<th>Units</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>t27</td>
<td>RAS enable time</td>
<td>110</td>
<td>105</td>
<td>ns</td>
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<td></td>
</tr>
<tr>
<td>t28</td>
<td>RAS disable time</td>
<td>8</td>
<td>0</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t29</td>
<td>Row Address setup</td>
<td>93</td>
<td>40</td>
<td>&gt; 0</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t30</td>
<td>Row Address hold</td>
<td>26</td>
<td>20</td>
<td>&gt; 15</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t31</td>
<td>RAS to CAS[] enable (read)</td>
<td>58</td>
<td>62</td>
<td>&gt; 25</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t32</td>
<td>CAS[] pulse width (read)</td>
<td>63</td>
<td>62</td>
<td>&gt; 60</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t33</td>
<td>CAS[] precharge period (read)</td>
<td>60</td>
<td>62</td>
<td>&gt; 50</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t34</td>
<td>Column Address setup (read)</td>
<td>13</td>
<td>20</td>
<td>&gt; 0</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t35</td>
<td>Column Address hold (read)</td>
<td>89</td>
<td>62</td>
<td>&gt; 20</td>
<td>ns</td>
<td>1</td>
</tr>
<tr>
<td>t62</td>
<td>ROMCS disable time</td>
<td>5</td>
<td>0</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t59</td>
<td>VIDAS, SDAK pulse width</td>
<td>62</td>
<td>62</td>
<td>&gt; 15</td>
<td>ns</td>
<td>2</td>
</tr>
<tr>
<td>t60</td>
<td>VIDAS, SDAK pulse space</td>
<td>62</td>
<td>62</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>t62</td>
<td>VIDAS, SDAK enable time</td>
<td>188</td>
<td>187</td>
<td></td>
<td>ns</td>
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</tr>
</tbody>
</table>

NOTES:
1. The DRAM timing limits are given for the particular DRAM used in the test system.
2. The VIDAS and SDAK pulse width limits were measured for a sample VIDC. A factor of two should be allowed for process variations.
### 8.8.3 Selecting a Video or Cursor DMA

**First Video/Cursor DMA request**

```
<table>
<thead>
<tr>
<th>VIDREQ</th>
</tr>
</thead>
<tbody>
<tr>
<td>\</td>
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<td></td>
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</tbody>
</table>
| HSYNC \\\
| \\\
| \\\
```

**Consecutive Video/Cursor DMA requests**

```
<table>
<thead>
<tr>
<th>VIDREQ</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
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<td></td>
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<td></td>
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<tr>
<td></td>
</tr>
<tr>
<td></td>
</tr>
</tbody>
</table>
```

<table>
<thead>
<tr>
<th>Sym</th>
<th>Parameter</th>
<th>Mes</th>
<th>Non</th>
<th>Lim</th>
<th>Units</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>t63</td>
<td>HSYNC setup to VIDREQ active</td>
<td>20</td>
<td>ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>t64</td>
<td>HSYNC hold from VIDREQ active</td>
<td>135</td>
<td>ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>t65</td>
<td>HSYNC setup for consecutive Video/Cursor DMA operations</td>
<td>75</td>
<td>ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>t66</td>
<td>HSYNC hold for consecutive Video/Cursor DMA operations</td>
<td>20</td>
<td>ns</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
8.9 I/O Controller Handshaking

This timing diagram applies when the processor accesses an I/O controller.

<table>
<thead>
<tr>
<th>Sym</th>
<th>Parameter</th>
<th>Mes</th>
<th>Non</th>
<th>Lim</th>
<th>Units</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>t67</td>
<td>IORQ setup (first attempt)</td>
<td>110</td>
<td>90</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t68</td>
<td>IORQ setup (retries)</td>
<td>42</td>
<td>50</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>t69</td>
<td>IORQ hold</td>
<td>58</td>
<td>50</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
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<td>ns</td>
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<td>t71</td>
<td>IOTG hold</td>
<td>10</td>
<td>ns</td>
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</tbody>
</table>
9. Packaging

The device is packaged in a JEDEC B ceramic leadless chip carrier, or a JEDEC C plastic leaded chip carrier (PLCC).

Suitable sockets for the devices are:
(i) AMP 55159-1 for the ceramic leadless chip carrier.
(ii) Bourny QILE68P-410T for the plastic leaded chip carrier (PLCC).
Appendix A. RAM address bus

The RAM address bus, RA[0:9], as output from the DRAM Address Multiplexer is derived from three sources:

(i) Processor address bus
(ii) Logical to Physical Address Translator
(iii) DMA Address Generators

During processor accesses to Physically mapped RAM, the higher order bits of the address bus, A[2:25], define the Physical page to be accessed, and the lower order bits define the word offset within that page. Similarly, when the processor accesses Logically mapped RAM, the Logical to Physical Address Translator supplies the Physical page number (provided that the access is successful). The row and column addresses supplied to the DRAM on RA[0:9] during processor accesses are a combination of the Physical page number (PPN[0:6]) and word offset (A[2:14]).

During DMA operations, the DMA Address Generators supply a 17-bit word address from which data is to be fetched. The DMA address is strobed to the DRAMs as a row and column address. The DMA Address Generators can only address 512KBytes, so the top bits of the address strobed to the DRAMs are padded with zeros to force the access in the bottom 512KBytes of memory.

Refresh operations use the address supplied by the Video pointer register in the DMA Address Generators.

The values output on the RAM address bus depend upon the Page size selected. Figure 13 shows the signal seen on RA[0:9] for each of the four Page sizes.

NOTES:
(i) The outputs of the DRAM Address Multiplexer pass through inverting pads, so the signals seen on RA[0:9] are inverted.
(ii) A[2:14] are 13-bits of the processor address bus that define the word offset within a Physical page.
(iii) PPN[0:6] are 7-bits that define the Physical page number being accessed.
(iv) DMA[2:18] are 17-bits from the DMA Address Generators that define the physical word address of a DMA read operation.